

STX13005

High voltage fast-switching NPN power transistor

Features

- High voltage capability
- Low spread of dynamic parameters
- Minimum lot-to-lot spread for reliable operation
- Very high switching speed

Applications

- Compact fluorescent lamp (CFL)
- Switch mode power supplies (AC-DC converters)

Description

The device is manufactured using high voltage multi-epitaxial planar technology for high switching speeds and medium voltage capability. It uses a cellular emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

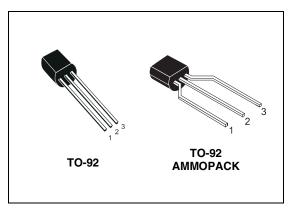


Figure 1. Internal schematic diagram

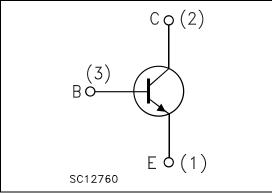


Table 1. D	evice summary ⁽¹⁾
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Order code	Marking	Package	Packaging
STX13005	X13005		Bulk
STX13005G	X13005G	TO-92	Duik
STX13005-AP	X13005		Ammonooli
STX13005G-AP	X13005G		Ammopack

1. The letter "G" in the order code suffix identifies the product as ECOPACK[®]2 grade. Please see Section 4 for details.

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1 Electrical ratings

Table 2.	Absolute maximum ratings			
Symbol	Parameter	Value	Unit	
V _{CES}	Collector-emitter voltage (V _{BE} = 0)	700	V	
V _{CEO}	Collector-emitter voltage (I _B = 0)	400	V	
V_{EBO}	Emitter-base voltage ($I_c = 0$; $I_B = 1.5 \text{ A}$; $t_p < 10 \text{ ms}$)	V _{(BR)EBO}	V	
Ι _C	Collector current	3	A	
I _{CM}	Collector peak current (t _P < 5ms)	6	A	
Ι _Β	Base current	1.5	A	
I _{BM}	Base peak current (t _P < 5ms)	3	A	
P _{tot}	Total dissipation at $T_c = 25^{\circ}C$	2.8	w	
T _{stg}	Storage temperature	-65 to 150	°C	
TJ	Max. operating junction temperature	150	°C	

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-c}	Thermal resistance junction-case max	45	°C/W



2 Electrical characteristics

 $(T_{case} = 25^{\circ}C \text{ unless otherwise specified})$

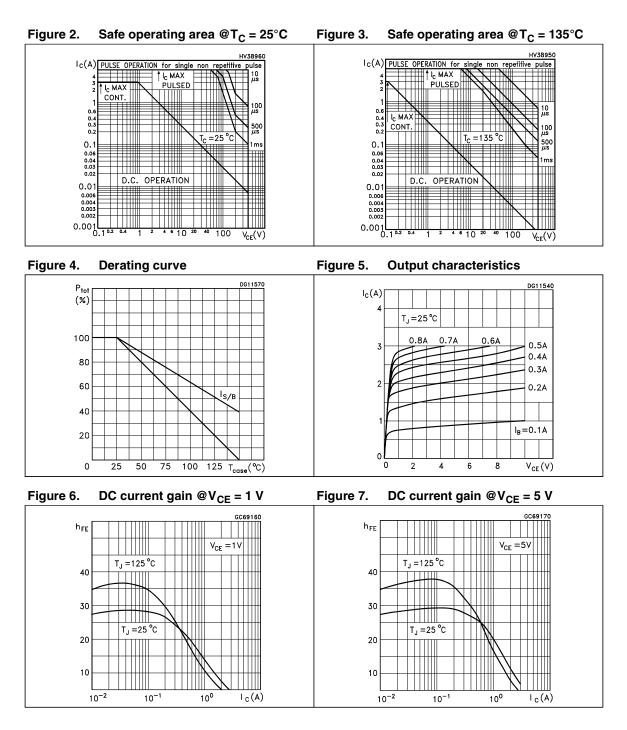
Table 4.	Electrical characteristics					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
lana	Collector cut-off current	V _{CE} =700 V			1	mA
I _{CES}	(V _{BE} =0)	$V_{CE} = 700 \text{ V}$ $T_{C} = 125^{\circ}\text{C}$			5	mA
I _{CEO}	Collector-cut-off current $(I_B = 0)$	V _{CE} = 400 V			1	mA
V _{(BR)EBO}	Emitter base breakdown voltage $(I_{\rm C}=0)$	I _E = 10 mA	9		18	v
V _{CEO(sus)} ⁽¹⁾	Collector-emitter sustaining voltage $(I_B = 0)$	I _C =10 mA	400			v
	Collector-emitter	I _C = 1A I _B = 200 mA			0.5	V
V _{CE(sat)} ⁽¹⁾	saturation voltage	$I_{\rm C} = 2A$ $I_{\rm B} = 500 {\rm mA}$			0.6	V
		$I_{\rm C} = 3A$ $I_{\rm B} = 750 {\rm mA}$			5	V
V (1)	Base-emitter saturation	I _C = 1A I _B = 200 mA			1.2	V
V _{BE(sat)} ⁽¹⁾	voltage	$I_{\rm C} = 2A$ $I_{\rm B} = 500 {\rm mA}$			1.6	V
h _{FF} ⁽¹⁾	DC current gain	$I_{\rm C} = 1 {\rm A}$ $V_{\rm CE} = 5 {\rm V}$	10		30	
UFE `	De current gain	$I_{\rm C} = 2 {\rm A}$ $V_{\rm CE} = 5 {\rm V}$	8		24	
	Resistive load	$I_{\rm C} = 2 {\rm A}$ $V_{\rm CC} = 125 {\rm V}$,			
t _s	Storage time	$I_{B1} = -I_{B2} = 400 \text{ mA}$		1.65		μs
t _f	Fall time	t _p = 30 μs		260		ns
	Inductive load	$I_{\rm C} = 1 \text{ A}$ $V_{\rm clamp} = 300 \text{ V}$,			
t _s	Storage time	$I_{B1} = 200 \text{ mA } V_{BE(off)} = -5 \text{ V}$,	0.8		μs
t _f	Fall time	L = 50 mH R _{BB} = 0		150		ns

 Table 4.
 Electrical characteristics

1. Pulse test: pulse duration \leq 300 µs, duty cycle \leq 2 %



2.1 Electrical characteristics (curves)



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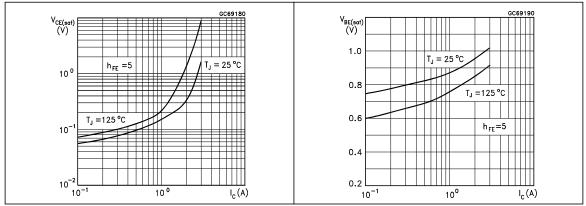


Figure 8. Collector-emitter saturation voltage Figure 9. Base-emitter saturation voltage



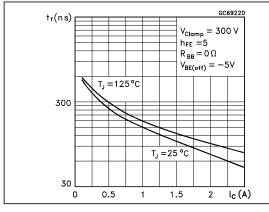
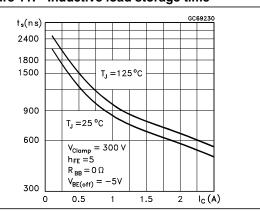


Figure 12. Resistive load fall time







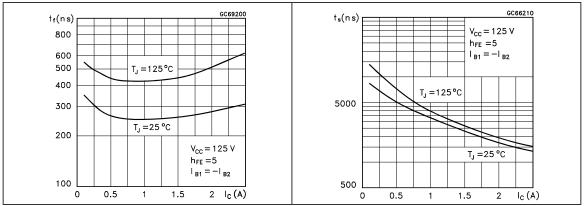
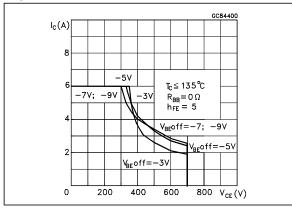




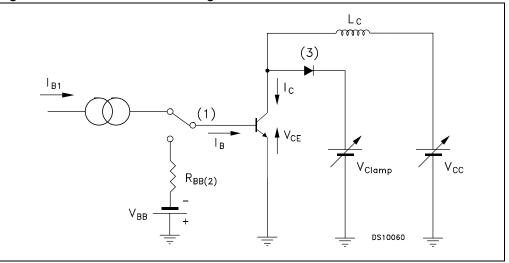
Figure 14. Reverse biased SOA





3 Test circuits

Figure 15. Inductive load switching test circuit

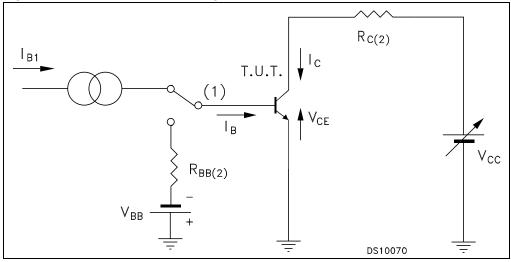


1) Fast electronic switch

2) Non-inductive resistor

3) Fast recovery rectifier

Figure 16. Resistive load switching test circuit



1) Fast electronic switch

2) Non-inductive resistor



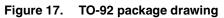
4 Package mechanical data

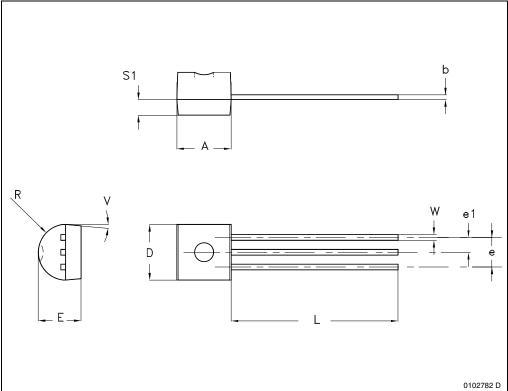
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



Dim.		mm			
Dini.	Min.	Тур.	Max.		
А	4.32		4.95		
b	0.36		0.51		
D	4.45		4.95		
E	3.30		3.94		
е	2.41		2.67		
e1	1.14		1.40		
L	12.70		15.49		
R	2.16		2.41		
S1	0.92		1.52		
W	0.41		0.56		
V		5°			

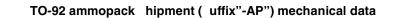
 Table 5.
 TO-92 package mechanical data

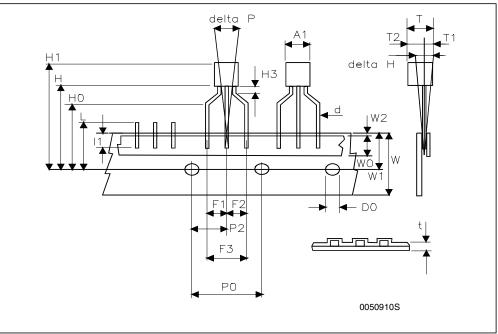






Dim.	mm			
	Min	Тур	Мах	
A1			4.80	
Т			3.80	
T1			1.60	
T2			2.30	
d			0.48	
P0	12.50	12.70	12.90	
P2	5.65	6.35	7.05	
F1,F2	2.44	2.54	2.94	
F3	4.98	5.08	5.48	
delta H	-2.00		2.00	
W	17.50	18.00	19.00	
W0	5.70	6.00	6.30	
W1	8.50	9.00	9.25	
W2			0.50	
Н	18.50		20.50	
H3	0.5	1	1.5	
H0	15.50	16.00	16.50	
H1			25.00	
D0	3.80	4.00	4.20	
t			0.90	
L			11.00	
11	3.00			
delta P	-1.00		1.00	







5 Revision history

Table 6.Document revision history

Date	Revision	Changes
01-Jul-2004	1	First release.
11-Feb-2005	2	New table on page 1
02-Aug-2007	3	New Figure 3 and updated Figure 14
28-Sep-2007	4	Updated Figure 2 and Figure 3
16-Dec-2008	5	Added ECOPACK [®] 2 grade products with suffix "G"
11-Aug-2009	6	Updated TO-92 mechanical data and <i>Figure 1: Internal schematic diagram</i>



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